High Capacitance for General Use KRM Series Specifications and Test Methods

No.	Item	Specifications	Test Method
1	Operating Temperature Range	X5R Char.: -55 to +85°C X6S Char.: -55 to +105°C X7R Char.: -55 to +125°C	Reference temperature: 25°C
2	Appearance	No defects or abnormalities	Visual inspection
3	Dimensions	Within the specified dimensions	Using calipers and micrometers
	Dielectric Strength	No defects or abnormalities	No failure should be observed when voltage in the table is applied between the terminations for 1 to 5 sec., provided the charge/discharge current is less than 50mA.
4			Rated Voltage Test Voltage DC25V, DC35V,
			DC50V, DC63V 250% of the rated voltage
			DC100V 200% of the rated voltage
5	Insulation Resistance (I.R.)	[KRM31] W.V.: 25V : More than $50M\Omega \cdot \mu F$ W.V.: $50V/100V$: More than $500M\Omega \cdot \mu F$ [KRM55] More than $100M\Omega \cdot \mu F$	The insulation resistance should be measured with Rated Voltage and within 60±5 sec. of charging.
6	Capacitance	Within the specified tolerance	
7	Dissipation Factor (D.F.)	[KRM31] W.V.: 25V : 0.15 max. W.V.: 50V : 0.025 max. W.V.: 100V : 0.05 max. [KRM55]	The capacitance/D.F. should be measured at reference temperature at the meaning frequency and voltage shown in the table. Nominal Capacitance Measuring Voltage
8	Capacitance Temperature Characteristics	X5R Char.: Within ±15% (Temp. Range: -55 to +85°C) X6S Char.: Within ±22% (Temp. Range: -55 to +105°C) X7R Char.: Within ±15% (Temp. Range: -55 to +125°C)	The capacitance measurement should be made at each step specified in the Table. Step
9	Strength of Metal Terminal	Termination not to be broken or loosened	A static load of 10N using a pressure rod should be applied to the center in the direction of the arrow and held for 10 s. Pressure Pressure Rod
10	Adhesive Strength of Termination	No removal of the terminations or other defect should occur.	Solder the capacitor to the testing jig (glass epoxy board) shown in Fig. 1. Then apply 10N force in the direction of the arrow. The soldering should be done using the reflow method and should be conducted with care so that the soldering is uniform and free defects such as heat shock. ToN, 10±1s Glass Epoxy Board Fig. 1

(*1) "Room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

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No.	Ite	em	Specifications	Test Method
11	Vibration Resistance	Appearance Capacitance D.F.	No defects or abnormalities Within the specified tolerance In accordance with item No.7	Solder the capacitor to the test jig (glass epoxy board). The capacitor should be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz, should be traversed in approximately 1 min. This motion should be applied for a period of 2 hrs. in each of 3 mutually perpendicular directions (total of 6 hrs.). Solder Resist Glass Epoxy Board
12	Deflection		No marking defects	Solder the capacitor to the testing jig (glass epoxy board) shown in Fig. 2. Then apply a force in the direction shown in Fig. 3. The soldering should be done using the reflow method and should be conducted with care so that the soldering is uniform and free of defects such as heat shock. 20 50 speed: 1.0mm/s Pressurize Flexure: ≤5
13	Solderability of Termination		RRM31 2.2 5.0 1.65 1.0	Capacitance meter 45 (in mm) Fig. 3 Reflow Soldering: Peak 260+0/-5°C The area of soldering 230°C min., 20 to 40 s Let sit for 24±2 h at room condition,* then measure. •Pretreatment Perform the heat treatment at 150+0/-10°C for 60±5 min. and then let sit for 24±2 h at room condition. (*1) 300°C 200°C 180°C 20 to 40 s 260+0/-5°C 230°C min.
14	Resistance to Soldering Heat I.R. II		No marking defects Within ±10% In accordance with item No.7 In accordance with item No.5 In accordance with item No.4	In case of Reflow Soldering See item 13 Solderability of termination In case of Soldering Iron Temp. of solder: 350±10°C Solder time: 4+1/-0 s Let sit for 24±2 hrs.at room condition,* then measure Please refer to "Caution (Soldering and Mounting) Correction with a Soldering Iron"

(*1) "Room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

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lo.	Ite	em	Specifications	Test Method
		Appearance	No marking defects	Fix the capacitor to the supporting jig (glass epoxy board) shown
		Capacitance Change	Within ±7.5%	in Fig. 4. Perform the 100 cycles according to the 4 heat treatments listed in the following table.
		D.F.	In accordance with item No.7	Let sit for 24±2 hrs. at room condition,* then measure.
		I.R.	In accordance with item No.5	Step Temperature (°C) Time (min.)
15	Temperature Cycle	Dielectric Strength In accordance with item No.4		1 Min. Operating Temp. ±3 30±3 2 Room Temp. 2 to 3 3 Max. Operating Temp. ±2 30±3 4 Room Temp. 2 to 3
			In accordance with item No.4	•Pretreatment Perform a heat treatment at 150+0/-10°C for 60±5 min. and then let sit for 24±2 hrs. at room condition. (*1) Solder Resist Cu Glass Epoxy Board Fig. 4
		Appearance	No marking defects	
	Humidity (Steady State)	Capacitance Change	Within ±15%	
16		D.F.	[KRM31] W.V.: 25V : 0.2 max. W.V.: 50V/100V : 0.05 max. [KRM55] 0.05 max.	Let the capacitor sit at 40±2°C and relative humidity of 90 to 95% for 500+24/-0 hrs. Remove and let sit for 24±2 hrs. at room condition,* then measure.
		I.R.	$ \begin{array}{l} [KRM31] \\ W.V.: 25V \\ : More than 12.5M\Omega \cdot \mu F \\ W.V.: 50V/100V \\ : More than 50M\Omega \cdot \mu F \\ [KRM55] \\ More than 10M\Omega \cdot \mu F \end{array} $	Pretreatment Perform a heat treatment at 150+0/-10°C for 60±5 min. and then let sit for 24±2 hrs. at room condition. (*1)
		Dielectric Strength	In accordance with item No.4	
		Appearance	No marking defects	
	Life	Capacitance Change	Within ±15%	Apply voltage as in the Table for 1000+48/-0 hrs. at maximum
		[KRM31] W.V.: 25V : 0.2 max. W.V.: 50V/100V : 0.05 max. [KRM55] 0.05 max.	W.V.: 25V	operating temperature ±3°C. Remove and let sit for 24±2 hrs. at room condition, (*1) then measure.
				Rated Voltage Applied Voltage DC25V, DC35V, C000(of the valid value to part of the value
				DC50V 200% of the rated voltage (2)
17				DC63V, DC100V 150% of the rated voltage
		I.R.	[KRM31] W.V.: 25V : More than $25M\Omega \cdot \mu F$ W.V.: $50V/100V$: More than $50M\Omega \cdot \mu F$ [KRM55] More than $10M\Omega \cdot \mu F$	The charge/discharge current is than 50mA. •Pretreatment Perform a heat treatment at 150+0/-10°C for 60±5 min. and then let sit for 24±2 hrs. at room condition. (*1) (*2) KRM31KC81E106, KRM31FR61E106, KRM31KR71H225 KRM31KR71H475: 150% of the rated voltage
		Dielectric		

^{(*1) &}quot;Room condition" Temperature: 15 to 35° C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa